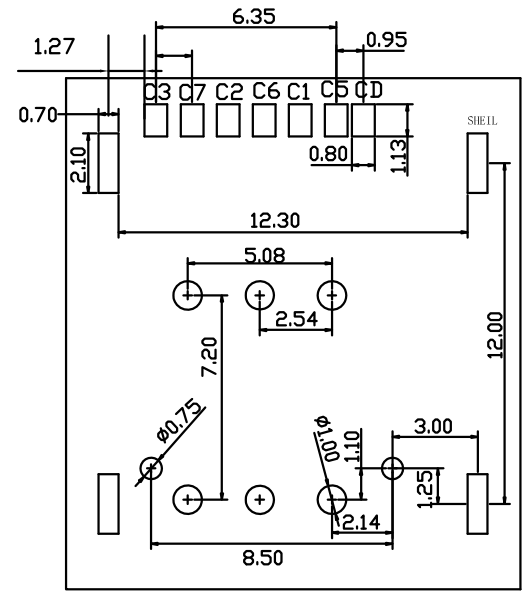
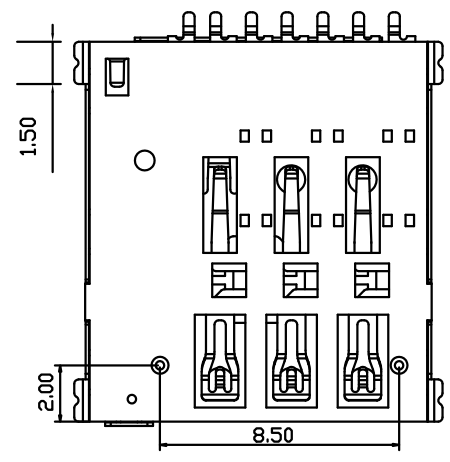
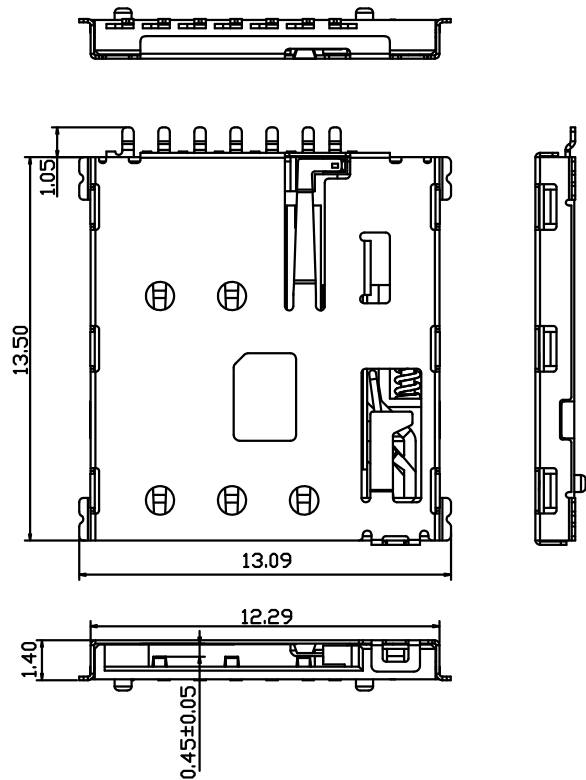


REV.	ECN.NO.	APPD.
A	/	/
A1	/	chenjianhui



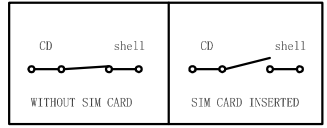
***Electrical Characteristics:**
 Contact Current Rating:0.5 Amperes.
 Dielectric Withstanding Voltage:AC500V r.m.s.
 Insulation Resistance:1000 MΩ Minimum.
 Contact Resistance:100 mΩ Maximum.

***Environmental:**
 Operating Temperature:-25°C~+90°C.

***Environmental:**
 Mating Cycles:3000Cycles.

***Mechanical Characteristics:**
 Card Push Insertion/Out Force:1.4kgf. MAX
 Contact Separation Force:0.20kgf Minimum.

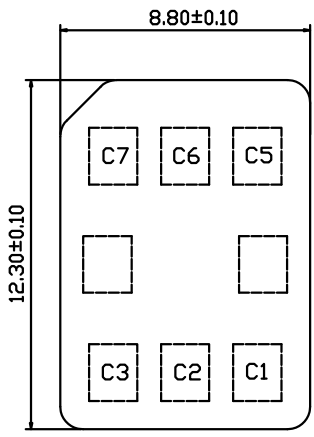
***Material:**
 Insulator:HI-Temp Plastic UL 94V-0 Rated.
 Contact:Copper Alloy,
 Shell:Stainless Steel,
 Spring:SWP.



SD5209-095-XXX8

G: 半金G/Fu
 1: 吸塑盘
 6: LCP黑色

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



TOLERANCE UNLESS OTHERWISE SPECIFIED		FLW 深圳市华联威电子科技有限公司			
.XXX ±0.10 .XX ±0.20 .X ±0.30		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.			
APPROVED		PART NAME:	NANO SIM PUSN 卡座		
CHECKED		PART No:	SD5209-095-G618	C	
DRAWN	chenjianhui	PROJECTION:	UNIT:	SCALE	SHEET
DATE	2022.12.23		mm	1:1	10F1
					REV. A1